LLB005 THRU LLB10

SINGLE PHASE GLASS PASSIVATED SURFACE MOUNT FLAT BRIDGE RECTIFIER

VOLTAGE: 50 TO 1000V CURRENT: 1.0A



FEATURE

Ideal for printed circuit board

Glass passivated chip

Reliable low cost construction utilizing molded plastic technique

High surge current capability

Small size, simple installation

High temperature soldering guaranteed:

260 °C/10 seconds/0.375" lead length at 5 lbs tension

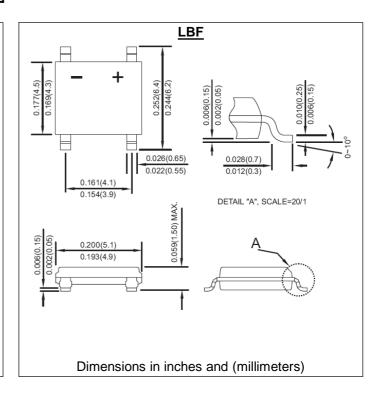
MECHANICAL DATA

Terminal: Plated leads solderable per

MIL-STD 202E, method 208C

Case:UL-94 Class V-0 recognized Flame Retardant Epoxy

Polarity: Polarity symbol marked on body



MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

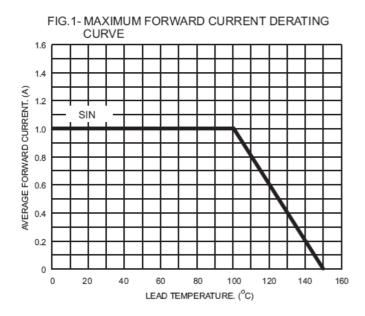
(single-phase, half -wave, 60HZ, resistive or inductive load rating at 25°C, unless otherwise stated, for capacitive load, derate current by 20%)

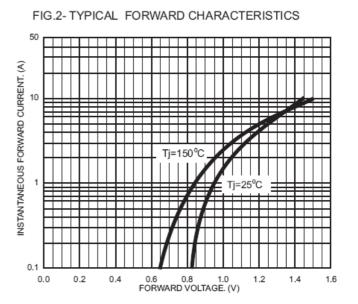
	Symbol	LLB	LLB	LLB	LLB	LLB	LLB	LLB	Units
		005	01	02	04	06	08	10	
Maximum Recurrent Peak Reverse Voltage	Vrrm	50	100	200	400	600	800	1000	V
Maximum RMS Voltage	Vrms	35	70	140	280	420	560	700	V
Maximum DC blocking Voltage	VDC	50	100	200	400	600	800	1000	V
Maximum Average Forward on aluminum substrate	1.0						А		
Rectified Current on glass-epoxy P.C.B.	If(av) 0.8								
Peak Forward Surge Current 8.3ms single half sine-	Ifsm	fsm 30.0							Α
wave superimposed on rated load	113111								
Maximum Instantaneous Forward Voltage at forward	Vf	0.95							V
current 0.4A	V 1								
Maximum DC Reverse Current Ta =25 $^{\circ}$ C	Ir 5.0 100.0								
at rated DC blocking voltage Ta =125 $^{\circ}$ C									μΑ
Typical Thermal resistance junction to lead	Rth(jl) 25								
on aluminum substrate	Rth(ja)	62.5							°C/W
on glass-epoxy P.C.B.		80							
Storage and Operating Junction Temperature Range	Tstg, Tj	-55 to +150							$^{\circ}\mathbb{C}$

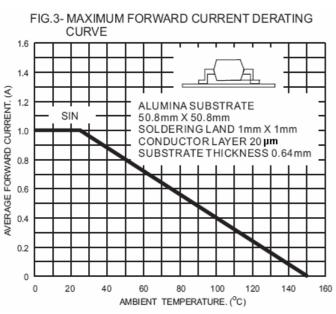
Note:

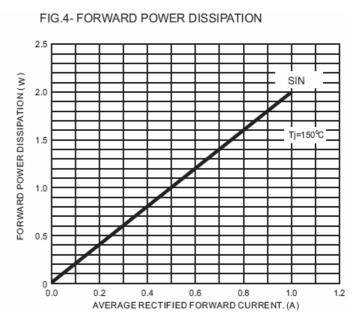
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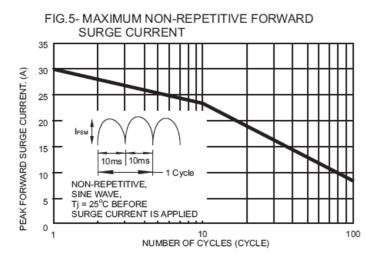
RATINGS AND CHARACTERISTIC CURVES LLB005 THRU LLB10











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